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Model identification for impact dynamics of a piezoelectric microactuator

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Abstract
A parameterized model for the impact dynamics of a piezoelectric microactuator is proposed, and a system-identification procedure for quantifying model parameters is presented. The proposed model incorporates squeeze-film damping, adhesion and coefficient-of-restitution effects. Following parameter quantification from sample data of bouncing impacts and progressive ramped-square-wave inputs, the model is found to be effective in predicting the time response of the actuator to a range of square-wave and sinusoidal inputs. The main contributions of this paper are to show that the dynamic response to micro-scale contact can be predicted using simple lumped-parameter modeling after a proposed system-identification procedure is performed and that certain small-scale forces can be quantified. For example, for motions where bounce of the cantilever tip may occur, the range of adhesion is found to be time dependent and vary between approximately 20 and 520 nN, while the range of squeeze-film damping is estimated to be between 50 and 130 nN, depending on the input signal frequency and amplitude. The presence, absence and quantity of bounces upon impact are predicted very accurately, while oscillation amplitudes and contact durations are predicted to be between 1% and 30% error for the majority of many test cases of periodic inputs between 5 and 100 Hz.

1. Introduction
Contact dynamics of microsystems are often complex and difficult to model, due to the existence of various small-scale, nonlinear forces affecting the behavior of micro-scale objects before, during and after contact. While various models have been proposed for different physical situations, when a microstructure must interact with its external environment, it may be especially useful to obtain a dynamic model without full knowledge of the geometry or properties of the interacting surfaces. In this paper, a model is developed for contact dynamics of a silicon proof mass driven by a piezoelectric actuator into contact with an underlying, irregular silicon 'ground' surface. The geometry of the proof mass and the piezoelectric forcing are intended to approximate the contact between the foot of a terrestrial micro-robot and the terrain on which it operates. Methods for modeling and/or identifying the forces acting on such a robot foot are potentially very useful for predicting walking gait performance of prototype micro-robots based on piezoelectric thin films.

Previous studies of contact behavior of MEMS devices have most often relied on accurate knowledge of interacting surface geometries. This is especially true for studies of scanning probe technologies, as in atomic force microscopy [1] or probe storage research [2], which has allowed extremely detailed studies of contact dynamics for such instruments. For applications with larger interacting surfaces, on the order of 10–1000 μm, the most prevalent area of contact modeling is for micro-electromechanical switches [3, 6–13], with additional work being done on certain vibration scavenging [4] or miniature gear devices [5]. Table 1 shows a summary of many contact models from the literature for interacting surfaces at this scale. In all cases, the geometries of the interacting surfaces are taken to be well known, and nearly all cases involve electrostatic forcing. A variety of models for impact, adhesion and damping behavior have been utilized, and these have enabled accurate predictions of certain specific phenomena during one or more impact events. More specifically, among closely related models in table 1, Decuzzi [7] and Do [8] investigated trends in adhesion/contact force for different environments and Do [8], LaRose [10] and McCarthy [11]
suggested novel impact/bounce models over various substrate conditions, which are used to inform the lumped-parameter modeling in this paper. Additionally, for models based on an assumption that the geometry of the contact surfaces is well known, close estimation of the short-ranged forces was conducted in several studies, including use of the Reynolds equation for squeeze-film damping [3, 6, 7, 10, 11] and various adhesion/contact force models such as Johnson–Kendall–Roberts (JKR) [3] or Lennard–Jones force [12]. However, a common drawback in these models, besides the absence of explicit experimental validation of the model over prolonged periods in the time domain, which is crucial for the analysis of the influence of various small-scale nonlinear forces during locomotion of a terrestrial micro-robot.

The approach taken in the following study is to attempt to model contact behavior using simplified and parameterized models for relevant interaction forces and to apply system-identification techniques to quantify these parameters without detailed knowledge of the interacting surface geometries or properties. This approach allows a wider variety of impact phenomena to be predicted than has been achieved by most other models for devices with similar dimensions; these phenomena include the presence of bouncing events, contact duration and oscillation amplitudes during periodic operation. Naturally, the limitation of this approach relative to prior works is that the model parameters cannot at this time be predicted from basic material properties, although prior works provide information on which small-scale factors to include. A second limitation of the current model is that fundamental underlying forces, such as the Van der Waals force, may be obscured in lumped parameter representations. Meanwhile, another advantage and difference between this model and other prior models is that electrostatic forcing, one of the dominant factors in most micro-electromechanical switch models, is nearly negligible for the piezoelectric test structure being analyzed, which in some situations makes other small-scale phenomena more impactful on device response.

### 2. System model

The system model consists of a lumped parameter model approximating the modal dynamics of the test structure,
an empirically derived model for internal forcing applied by the piezoelectric thin film on the cantilever beam, and parameterized squeeze-film damping, adhesion and impact models for ground interaction.

3.1. Structural dynamics

The structural dynamics of the cantilever beam and proof mass are modeled in the form

$$ M\ddot{x} + B\dot{x} + Kx = U, $$

Figure 1. (a) Micro-cantilever test structure, (b) fabrication process and (c) image of cantilever from optical microscope.
convenience, the state vector of the system of second order, with states matrices, respectively, and setup.

Figure 2. Measurement instruments and experimental setup: (a) schematic view and (b) photograph of the laser Doppler vibrometer setup.

where $M$, $B$ and $K$ are linear mass, damping and stiffness matrices, respectively, and $U$ is a vector of forcing inputs. For convenience, the state vector of the system $x$ is chosen to be of second order, with states $x_c$, displacement at the center of the cantilever, and $x_p$, displacement at the center of the proof mass (i.e. $x = [x_p \ x_c]^T$). While this allows only the two most prominent vibration modes of the system to be captured in the dynamic model, both these states are simple to measure using available instrumentation, and the forcings to the system are approximately decoupled into forces acting on the cantilever and proof mass, respectively. This allows $U$ to be modeled in the form

$$U = \begin{bmatrix} u_{c0} + u_{c,pzt}(V(t^- | t^- < t)) \\ u_{p0} + u_{p,g}(x_p, t) \end{bmatrix},$$

where $u_{c0}$ and $u_{p0}$ are fixed, constant sources of structural deformation due to residual stresses from the fabrication process, $u_{c,pzt}$ is the sum of internal driving forces in the cantilever beam, which is a function of the applied voltage to the system $V$ and influenced by the history of that voltage input up to the current time $t$, and $u_{p,g}$ is the sum of external forces generated through interaction with the ground, which depends on position and velocity of the proof mass.

Because the neutral position of the system when no voltage is applied is dependent on the voltage history of the piezoelectric film, the zero positions for $x_c$ and $x_p$ are defined by applying a specified voltage function prior to each identification experiment, namely a polarization signal $V_{pole}(t)$ represented by

$$V_{pole}(t) = \begin{cases} 10, & t < 0 \\ 0, & t \geq 0 \end{cases}.$$  \hspace{1cm} (3)

Then, the neutral position of the system is defined as the solution to

$$K x_0 = \begin{bmatrix} u_{c0} + u_{c,pzt}(V_{pole}(0)) \\ u_{p0} \end{bmatrix},$$

or in other words, zero positions are the position of the cantilever and proof mass in air after poling the PZT film at 10 V (in practice, 10 V is applied for 10 min, with at least 1 min before measurement of cantilever and proof mass position by optical profilometry or LDV). Then, the dynamic system to be analyzed in terms of contact dynamics is described by differential states $\delta x = x - x_0$ and $\delta u = u - u_0$ and differential forces $\delta u_c(t)$ and $\delta u_p(t)$:

$$M \delta \ddot{x} + B \delta \dot{x} + K \delta x = \begin{bmatrix} u_{pzt}(V(t^- | t^- < t)) - u_{pzt}(V_{pole}(0)) \\ u_{p,g}(x_p, \delta x_p, t) \end{bmatrix} = \begin{bmatrix} \delta u_c(t) \\ \delta u_p(t) \end{bmatrix}.$$ \hspace{1cm} (5)

This formulation thus eliminates the effects of constant sources of strain from the model (such as residual strain in non-active thin films) and leaves for further identification models for piezoelectric forcing and ground interaction. Numeric values for $M$, $B$ and $K$ are obtained from the conventional modal analysis with a low voltage (1 V) swept sine input, using the circle fit method [17]. The most prominent resonant peaks for the experimentally tested system occur at 623 and 6424 Hz.

3.2. PZT Model

The forcing applied to the cantilever by the piezoelectric thin film as a function of voltage, equivalent to a net force applied to the cantilever beam relative to the reference force producing the neutral deflection after poling, i.e.

$$\delta u_c(t) = u_{pzt}(V(t^- | t^- < t)) - u_{pzt}(V_{pole}(0))$$ \hspace{1cm} (6)
from (5), is a very complex function of the voltage signal experienced by the PZT film up to the current time. This is especially true when both positive and negative electric fields are in use, as the polarization state of the film itself may vary from that achieved after poling. However, for strictly periodic input signals with a limited range of amplitudes used in the current work, it was found that the piezoelectric forcing could be approximated by comparatively simple and experimentally identifiable polynomial functions, such that

$$\delta u_c(t) \approx g_c(V(t), \dot{V}(t)).$$

Here, $g_c$ is an empirically fit hysteresis model for PZT actuation gain from static bending tests.

The function describing $g_c$ is identified as a function of voltage by solving the equation

$$K_{1,1}\delta x_c = g_c(V, \dot{V})$$

for a number of voltage cycles and fitting polynomial curves to the hysteresis loops. Here, $K_{1,1}$ is the estimated stiffness of the cantilever from the structural model and $\delta x_c$, the displacement of the center of the cantilever from its zero position, is being measured during static bending tests.

Figure 3(a) shows static displacements versus voltage for a cantilever beam stepped in increments from 0 V (after poling) back to $-8$ V, up to $8$ V, and back to $-8$ V. As it illustrates, the position of the proof mass is bound when the voltage reaches close to $8$ V and it stays at the same position until the voltage falls back to $-2$ V. This is attributed to adhesion and this hypothesis is strengthened by the fact that the proof mass seems to be ‘released’ from the ‘ground’ surface when the voltage becomes negative. Figure 3(b) shows the second experimental data where the range of voltage is from $-6$ to $6$ V, which just avoids contact with ground for quasi-static motion and thus features no adhesion effect, as visible in the continuous changing in position of the proof mass during the voltage drop from $6$ to $0$ V. While there is a substantial variation from cycle to cycle, as visible in figure 3(c), for the main purpose of contact modeling, an average empirical fit for $g_c$ was found as

$$g_c(V) = \begin{cases} 
0.0076 V^2 - 0.6062 V - 0.6350 & \text{if } \dot{V} < 0 \\
0.0016 V^3 - 0.0255 V^2 - 0.7057 V + 1.4796 & \text{if } \dot{V} > 0 
\end{cases}$$

It should be noted that the full trajectory of the proof mass positions over a larger range of voltage would look like the plot on the bottom left corner of figure 3(c), which is a typical ‘butterfly’ feature of bipolar hysteresis of thin-film PZT actuators. For this study, only one side of the butterfly curve is in use, and the curve here is not symmetric along the 0 V line due to some inherent polarization of the PZT thin film during the fabrication process.

Because the error in the piezoelectric model can produce error in the parametric models for contact dynamics, at the conclusion of parameter identification a sensitivity analysis to alter the piezoelectric model is performed by varying the presumed zero position of the proof mass above the ground surface and repeating parameter identification as if that had been the true zero position of the structure (in effect shifting the piezoelectric gain to the extent of its experimental range). As will be discussed later, the contact model parameters prove relatively insensitive to changes in the piezoelectric model, although improved hysteresis modeling is a potential area of future work for modeling of the system as a whole, especially when a wider range of voltage amplitudes may be applied.
3.3. Impact modeling

The goal of impact modeling is to identify a comparatively simple, parameterized model describing behavior when the proof mass at the tip of the cantilever impacts with the underlying ‘ground’. Although this test structure used for model development can only interact with one surface, conceptually it should be possible to adjust the parameters describing the impact model to describe a variety of other surface interactions. The impact model developed here consists of lumped-parameter squeeze-film damping and adhesion models, together with a coefficient-of-restitution test for bouncing.

When the proof mass is not in contact with the ground, \( \delta u_p(t) \) is estimated using a parameterized squeeze-film damping equation,

\[
\delta u_p = C_s \frac{\dot{x}_p}{(x_p + g_p)^2}, \quad x_p > -g_p.
\]  

where \( g_p \) is the effective distance between the proof mass and ground at the zero position for the proof mass, and \( C_s \) is a lumped coefficient incorporating viscosity and other squeeze-film damping factors. \( C_s \) and \( g_p \) are tuned experimentally during the system-identification procedure in the following section. The value for \( g_p \) is not identical to the value for \( d_p \), which is the distance between the proof mass zero position and ground because the uneven shape of the underlying silicon results in an effective non-zero gap when the proof mass is in contact, as shown schematically in figure 4.

If the proof mass comes into contact, the external ground-interaction force becomes a function of adhesion to ground, which is given in a general form:

\[
\delta u_p = f_a(t - t_c), \quad x_p = -d_p,
\]  

where \( t_c \) is the time at which the current period of contact began, and \( f_a \) is an experimentally identified function for the adhesion force to be identified.

To determine whether the proof mass sticks or bounces at impact, a coefficient of restitution (CoR) model is used. First, at the moment of impact, the estimated bounce velocity is calculated from

\[
\dot{x}_p = -\alpha \dot{x}_p^+, \quad (12)
\]  

where \( \dot{x}_p^+ \) is the proof mass velocity just before impact, \( \dot{x}_p^- \) is the hypothesized velocity after impact, and \( \alpha \) is an experimentally determined CoR. Then, the pulling-off force associated with such a change in the velocity is calculated from the dynamics of the remainder of the system as

\[
f_{\text{pull}} = -K_{2,1} \delta x_c - C_{2,1} \delta \ddot{x}_c + K_{2,2} \delta x_p + C_{2,2} \delta \ddot{x}_p. \quad (13)
\]

If \( f_{\text{pull}} \) is positive after the hypothesized bounce and is larger than \( f_a(t - t_c) \), then the proof mass velocity is calculated from (12); otherwise, the proof mass is taken to be in sustained contact with ground, and the adhesion force from (11) is applied until \( f_{\text{pull}}(t) \) at a future time exceeds \( f_a(t - t_c) \).

Figure 4. Cross-sectional diagram and expected ground surface: (a) schematic diagram of the test structure and (b) conceptual diagram of inferred cross-sections.

4. Impact parameter identification

Given that structural and piezoelectric models for the system from section 2 have been developed based on non-contact and static bending tests, three parameters and one function must be identified to finalize an impact model of the form proposed in (10)–(13). These are the squeeze-film coefficient and the effective gap between proof mass and ground, CoR and adhesion force function.

The CoR is most easily identified, by gradually increasing voltage to the system at a fixed oscillation frequency, in the present example 300 Hz, until the proof mass just begins to impact the ground, without any sustained adhesion. A number of impact events are measured under the LDV, and the proof mass velocity is calculated before and after impact. The corresponding CoR is taken from the average value of many impacts, as shown in figure 5.

For adhesion and squeeze-film damping, a series of experiments was performed using ramped square waves. Defined in terms of frequency, voltage, and a duty cycle variable, as shown in figure 6, the ramped square waveform was found to be effective for producing comparatively gentle contact events with gradual changes in contact time for adhesion measurements. Furthermore, immediately after break-off, the ramp-up keeps the proof mass close to ground and accentuates squeeze-film damping effects.

To perform adhesion measurements, the pulling-off force from (13) acting on the proof mass is calculated using...
Figure 5. Ratio of proof mass velocity after impact to velocity before impact, for 16 sample bouncing events (300 Hz square wave/300 Hz sine wave).

Figure 6. Sample ramped-square waveform used for adhesion and squeeze-film damping measurements.

Figure 7. Sample proof mass position versus time with ramped-square wave, superimposed over inferred pull-off force.

As shown in figure 7, adhesion is taken to increase as contact time increases (with a linear trend proving consistent with experimental data), and the proof mass is released from the ground pulling-up force equal to the adhesion force. Figure 8 shows the adhesion force calculated from the pull-off force at break-off versus the contact duration for ramped square waves with varying \( \lambda \) at 5 Hz and 8 V amplitude. While a relatively limited range of contact durations is obtained in this manner, a linear trend in the adhesion force with time is observed. This is consistent with some prior adhesion studies of microdevices, including [18–21], although the time periods of the present test are generally shorter (and adhesion force smaller) than in existing MEMS adhesion studies. The resulting adhesion model was identified using slope \( C_a \) and constant \( C_{a0} \) as

\[
f_a = C_a \left( t - t_c \right) + C_{a0}.
\]

Also visible in figure 7 is the oscillation of the proof mass after break-off, as it rises away from ground. This is a consequence of the sudden break-off against adhesion, and its peak amplitude and decay rate are used to fit the parameters of the simplified squeeze-film damping model in (10). As shown in figure 9, by adjusting the effective squeeze-film damping coefficient \( C_s \) and effective proof mass gap \( g_p \), such that the decay in oscillations are matched between the dynamic model and experimental results. Table 2 shows the coefficients obtained for the current test structure. Figure 10 shows an
Figure 9. Comparison of decay in oscillations of displacement of the proof mass following break-off with and without squeeze-film damping incorporated in the dynamic contact model.

Figure 10. Sample response of experimental system and simulated system following model parameter identification to a ramped square wave (5 Hz, 8 V, $\lambda = 25\%$).

example of the agreement between the dynamic model with identified coefficients and a sample ramped-square wave over a full cycle period.

To check the sensitivity of identified parameters to piezoelectric coefficient modeling, the above procedure was repeated assuming a piezoelectric gain function shifted by the equivalent of 20 $\mu$m of zero position of the proof mass $d_p$ shown in figure 11. This offset was approximately equal to the maximum cycle-to-cycle deviation of static bending tests. Table 2 shows the comparison of contact dynamics model parameters under the two different piezoelectric forcing scenarios and this implies that the identified parameters are largely insensitive to the error of the estimated piezoelectric gain behavior.

5. Model validation

To verify that the contact model identified from static, simple bouncing and ramped-square wave experiments is effective for modeling a wider range of contact scenarios, several additional experiments were run with periodic input functions of varying form, frequency and amplitude. A summary of test cases of square or sine input and 6 V or 8 V driving voltage at 5, 15, 50 and 100 Hz (16 cases total) is provided in table 3, with regard to the presence and number of bouncing events, the peak amplitude of oscillations after break-off and the contact duration. Results from the full 16 test cases are shown in the appendix. The ranges of tested frequencies and waveforms were chosen considering the practical voltage inputs for micro-robots, which are typically low-power frequency square waves, with sine waves as a possible alternate. Voltages were limited to 6 and 8 V to avoid non-contact cases at lower voltages and higher voltage cases where piezoelectric driving force overpowered small-scale phenomena. Although some centimeter-scale micro-robots may utilize resonant frequencies, it was assumed that simple waveforms with lower frequencies would be still helpful to validate the contact model due to comparatively large time duration of contact interaction with the ground.

The simplified, lumped parameter model identified to describe system contact dynamics captures the majority of major events seen in the validation tests. The presence or the absence of bouncing events was predicted correctly in all cases, although some predictions give a mismatch for the number of bounces in the cases at lower voltage inputs. About 60% of all test cases showed the identical number of bounces. Contact duration predictions are generally good, with error not greater than 30% in more than half of the test cases. The contact duration is least reliable for the cases of lower voltage

![Figure 11. Idle position $d_p$: the distance between the proof mass and the substrate surface while the system is idle.](image)

<table>
<thead>
<tr>
<th>Table 3. Summary of model validation results.</th>
</tr>
</thead>
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<tr>
<td>Existence of bounce prediction correctly</td>
</tr>
<tr>
<td>---------------------------------------------</td>
</tr>
<tr>
<td>100%</td>
</tr>
</tbody>
</table>

8
input, with substantial errors seen in a few test cases. The peak oscillation error was lower than 30% in nearly all cases, with greater errors observed only for some square-wave tests. Errors are attributed primarily to unmodeled minor vibration modes, particularly when excited by step inputs, and also to the complicated hysteretic behavior of piezoelectric actuation. An error may also arise from some small contribution of electrostatic attraction, primarily at higher frequencies; in the experimental setup, the electrostatic force is minimized as a result of grounding the bottom PZT electrode, but if any electrostatic force exists, only its static effects are accounted for through the influence of electrostatic attraction on the calculated piezoelectric gain function. Nonetheless, even the worse test cases give a fair agreement with overall periodic time response, as shown in figures 12(a) and (b), despite the numerically quantified errors. Overall, 50% of all test cases showed less than 30% error in both peak oscillation error and contact duration predictions, and again, the presence or the absence of bouncing was predicted correctly in all cases.

Other representative responses are also shown in figure 13. Figure 13(a) shows the very close agreement between simulation and experimental results at low frequencies, using identified model parameters. At higher frequencies, such as the 50 Hz results in figures 13(b) and (c), greater differences occur, with unmodeled minor vibration modes especially evident in the response to an 8 V sinusoidal input in figure 13(c). This difference, however, does not severely increase even in higher driving frequencies as seen in figure 13(d); the general response amplitude is quite close even when higher mode oscillation amplitudes are off. Generally speaking, the match between simulation and real system behavior over the entire duration of periodic validation trajectories appears unusually good for a micro-scale dynamic contact model.

6. Discussion

The goal of this work was to develop a relatively simple model for contact dynamics of a microdevice, along with a procedure to quantify parameters in the model. Simply, in this context, a primarily lumped-parameter model with a limited numbers of parameters has been indicated, rather than potentially more accurate distributed or finite-element models. The major benefit of the completed model after parameter identification is that it provides good prediction in the simulation of a variety of experimentally measured transient and periodic phenomena.

The ability to replicate a variety of dynamic responses is unusual for a model of contact dynamics of a MEMS device with relatively large areas subject to surface interactions. Also important is that the model can be obtained when information about device geometries and surface conditions is limited. This model approach is able to do this, though, because it uses a subset of experimental system inputs and measured responses to quantify coefficients in a generic system model, rather than attempting to make predictions from specific system geometries and material properties. This means that the approach used here has a limited utility for predicting behavior at the design stage of a given device and is not at this time able to provide insight into the effects of material choices. On the other hand, once systematic identification is made, response of the system to alternative inputs, as provided by feedforward or feedback control, or perturbations to the contact model, made through adjustments to model parameters, can be estimated.

Regarding the specific model contents proposed in this paper, the main difference from most previous work with large contact areas is the use of piezoelectric actuation, such that electrostatic forces are less prominent than in other applications, and squeeze-film damping and adhesion forces tend to be more important. Meanwhile, while piezoelectric actuation is common in the more precisely defined contact interactions of atomic force microscopy and similar techniques, contact geometries studied here are much different. The forms for squeeze-film damping and adhesion forces have been chosen based on common forms used in references treating devices in dimensions similar to the micro-cantilever test structure tested in this paper, but reduced when possible so that each force is formulated with a simple few coefficients. In terms of more general applications, the form for squeeze-film damping is not unusual. Meanwhile, the exact functional form (linear fit) of the adhesion force model may be dependent on the material combination used, though at least some region of linearly increasing adhesion force with contact
time is often observed in other research, and the procedure for generating the pull-off force is generally applicable. Likewise, the hysteresis model for the PZT thin film used here is entirely case specific, and much more sophisticated hysteresis models could replace it in other applications. Additionally, since electrostatic force is obscured in this hysteresis model, its contribution to the dynamics of the structure is ignored. This may contribute to error in responses under high driving frequencies. Hence, further development of the hysteresis model including the dynamic behavior of electrostatic force might reduce error. Finally, coefficient-of-restitution models for bouncing behavior have been applied to microsystems previously, but prove effective again in this work.

Similarly, the system-identification approach proposed has some nice generally applicable attributes, and a few aspects that are not necessarily applicable in all cases. The provided sequence generally separates individual phenomena, although certain phenomena are not entirely isolated, such as hysteresis measurements and electrostatic forces. Likewise, if applied to other devices may not be able to reduce close range effects by shifting the neutral position of other devices in the same manner that a piezoelectric cantilever can be polarized in opposite directions. One aspect of the procedure that can be useful to estimate the forces like adhesive force and squeeze-film damping force is the ramped-square input signal with various slopes, which has been designed and applied to the system.

7. Conclusion

Using a cantilever-type thin-film piezoelectric actuator, this work introduces a procedure for model identification of contact dynamics of a piezoelectric microsystem without full knowledge of contact surface geometry. The model uses simple lumped-parameter components that whose parameters can be identified with relatively simple experimentation. Certain piezoelectric linearities plus squeeze-film damping and adhesion effects and a coefficient-of-restitution characterizing the surfaces in question are incorporated into the model. Experimental validation indicates that the model overall provides a fair approximation of transient and periodic behavior over various driving frequencies and waveforms in time series responses. Effects that are captured well include the amplitude and phase shifts in response to sinusoidal inputs, the presence or the absence of bouncing at contact and the attenuation rates of transient oscillations. The peak amplitude of oscillation, duration of contact and high mode

Figure 13. Sampling of validation test signal results, best cases: (a) sine wave 8 V 15 Hz, (b) sine wave 8 V 50 Hz, (c) square wave 8 V 50 Hz and (d) sine wave 8 V 100 Hz.
oscillation in the air at a driving frequency faster than 50 Hz are less well modeled, although in most cases the agreement of experimental and simulated responses is quite good.

The results of this modeling effort will next be applied to more practical device applications. The primary application area is micro-robotics, where even though it is difficult to predict coefficients before hand over many terrains, for design of gait inputs a designer can look at the response to system inputs over a range of coefficients and pick input sequences producing a robust response. In other circumstances, it may be possible to perform partial or complete identification, while initiating locomotion and using the resulting information to provide trajectories with desirable behavior.

Acknowledgments

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Appendix. Sampling of all test cases

A full set of measurements from 16 validation test cases is shown in table A.1.

<table>
<thead>
<tr>
<th>Frequency (Hz)</th>
<th>Voltage (V)</th>
<th>Signal</th>
<th>Number of bounces</th>
<th>Peak oscillation amplitude (μm)</th>
<th>Error</th>
<th>Contact duration (ms)</th>
<th>Error</th>
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<td>Square</td>
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<td>Sim: 97</td>
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<td>Sim: 114</td>
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<td>Sim: 31</td>
<td>58%</td>
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<tr>
<td></td>
<td></td>
<td></td>
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<td></td>
<td>Exp: 75</td>
<td></td>
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<tr>
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<td>Sim: 264</td>
<td>−25%</td>
<td>Sim: 99</td>
<td>−2%</td>
</tr>
<tr>
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<td></td>
<td>Exp: 97</td>
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<tr>
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<td>Sine</td>
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<td>Sim: 72</td>
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<td></td>
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<td></td>
<td>Exp: 82</td>
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<tr>
<td>15</td>
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<td>Square</td>
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<td>Sim: 216</td>
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<td></td>
<td></td>
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<td>Exp: 0</td>
<td>Exp: 236</td>
<td></td>
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</tr>
<tr>
<td>15</td>
<td>6</td>
<td>Sine</td>
<td>Sim: 0</td>
<td>Sim: 114</td>
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References


contact mechanics of electrostatically actuated RF-MEMS switches. *Annu. Conf. IEEE Industrial Electronics Society (Glendale, AZ)* pp. 2293–8


